

Report No. APR-22-H0212-B Date: Nov. 01, 2023

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

SERIES: UPC842G2

DEVICE: UPC842G2-A

UPC842G2-E1-A UPC842G2-E2-A UPC842G2-AP UPC842G2-E1-AP UPC842G2-E2-AP

For both products manufactured by Naito Densei Sado Factory (NDK) and UTAC THAI Limited (UTL)

APPLICATION: Standard

Quality Assurance Div. Renesas Electronics Corporation

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# Reliability test result

UPC842G2 (Standard)

| Test Items                           | Reference                 | Test Conditions  | Results<br>Reject/Size |
|--------------------------------------|---------------------------|--|------------------------|
| High Temperature<br>Operating Life   | JESD22-A108               | Ta=125 °C, Apply rated voltage, 1,000h   | 0/22                   |
| Temperature Humidity Bias (HAST)     | JESD22-A110               | Ta=85 °C, 85%RH, Apply rated voltage, 1,000h   | 0/22                   |
| Temperature Cycling                  | JESD22-A104               | Ta=-65 ~ 150 °C, 200 cycles  | 0/22                   |
| High Temperature Storage<br>Life     | JESD22-A103               | Ta=150 °C, 1,000h  | 0/22                   |
| Resistance to Soldering<br>Heat      | JESD22-A113,<br>J-STD-020 | Bake: 125°C, 24h  Moisture Soak:85°C85%RH, 168h(MSL=1)  Reflow:260°Cmax, 255°Cx30s, 3 times) | 0/22                   |
| Solderability                        | J-STD-002                 | 245°C, 5s (Solder wetting area 95% or more)  | 0/22                   |
| Electrostatic discharge (HBM Method) | JS-001                    | C=100pF, R=1.5k ohm, ±1,000V   | 0/3                    |
| Electrostatic discharge (CDM Method) | JESD22-C101               | ±500V  | 0/3                    |
| Estimated Failure Rate               | -                         | Estimated failure rate: 15Fit Ta= 55°C, Ea=0.7eV, C.L.=60%                                   |                        |

Reliability test results may include data from family representative products.

MSL Preconditioning was performed prior to Temperature Humidity Bias and Temperature Cycling.

### <Judgement criteria>

Electrical characteristics described in the delivery specification.

(Solderability test is excluded.)

## <Pre><Pre>conditioning Details>

125°C, 24h + 85°C85%RH 168h(JEDEC MSL1) -> Reflow(260°Cmax, 255°Cx30s, 3 times)